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APPLICATION NO		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKÉT NO.	CONFIRMATION NO.
10/813,437		03/31/2004	Kirti Srivastava	4062-115	3807
23117	7590	03/22/2005		EXAM	INER
		ERHYE, PC	DOUGHERTY, ANTHONY T		
1100 N GLEBE ROAD 8TH FLOOR				ART UNIT	PAPER NUMBER
ARLINGT	ON, VA	22201-4714	2863		
				DATE MAILED: 03/22/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/813,437	SRIVASTAVA ET AL.					
Office Action Summary	Examiner	Art Unit					
	Anthony T. Dougherty	2863					
The MAILING DATE of this communicatio Period for Reply	n appears on the cover sheet with	n the correspondence address					
A SHORTENED STATUTORY PERIOD FOR R THE MAILING DATE OF THIS COMMUNICATI - Extensions of time may be available under the provisions of 37 C after SIX (6) MONTHS from the mailing date of this communicati - If the period for reply specified above is less than thirty (30) days - If NO period for reply is specified above, the maximum statutory i - Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b).	ON. FR 1.136(a). In no event, however, may a repon. a reply within the statutory minimum of thirty period will apply and will expire SIX (6) MONTI statute, cause the application to become ABA	oly be timely filed (30) days will be considered timely. HS from the mailing date of this communication. NDONED (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on	30 June 2004.						
2a) ☐ This action is FINAL . 2b) ☑	This action is FINAL. 2b)⊠ This action is non-final.						
•	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims							
4) ⊠ Claim(s) 1-7 is/are pending in the applicate 4a) Of the above claim(s) is/are with 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1-7 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and subject to	hdrawn from consideration.						
Application Papers							
9) The specification is objected to by the Exa	miner.						
10)⊠ The drawing(s) filed on <u>30 June 2004</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.							
Applicant may not request that any objection t	o the drawing(s) be held in abeyanc	e. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the c	, -,						
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for fo a) All b) Some * c) None of: 1. Certified copies of the priority documents. Certified copies of the priority documents. Copies of the certified copies of the application from the International B * See the attached detailed Office action for	ments have been received. ments have been received in Ap priority documents have been re ureau (PCT Rule 17.2(a)).	plication No eceived in this National Stage					
Attachment(s)							
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-94 	4) ∐ Interview Su 8) Paper No(s)/	mmary (PTO-413) /Mail Date					
3) Information Disclosure Statement(s) (PTO-1449 or PTO/S Paper No(s)/Mail Date		ormal Patent Application (PTO-152)					

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DETAILED ACTION

Claim Objections

1. Claim 1 objected to because of the following informalities: Claim 1 recites the limitation " $K(z) = \overline{K} + K'(z)$ is the thermal conductivity" in line 9. There is insufficient antecedent basis for this limitation in the claim. It is assumed by the examiner that this is a typographical error in line 5 of claim 1 which reads:

"
$$\frac{d}{dz}\left\{\left(\overline{K}+K'(z)\right)\frac{dT}{dz}\right\}=-A(z)$$
"

and therefore line 5 of claim has been treated for examination purposes with respect to the prior art as if it reads

$$"\frac{d}{dz}\left\{K(z)\frac{dT}{dz}\right\} = -A(z)"$$

instead. Appropriate correction is required.

Claim 1 objected to because of the following informalities: Line 16 recites the limitation " σ_K^2 is the variance is thermal", (emphasis added) it is believed by the examiner that this is a typographical error and for clarity has been treated for examination purposes with respect to the prior art as if it reads " σ_K^2 is the variance in thermal" (emphasis added for identification of error only). Appropriate correction is required.

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Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1-7 rejected under 35 U.S.C. 102(b) as being anticipated by Research Note "A stochastic model to quantify the steady-state crustal geotherms subject to uncertainties in thermal conductivity" Kirti Srivastava and R.N. Singh Geophysical journal International (1999) Volume 138, pp. 895-899 (hereinafter Srivastava et al.).

With regard to claim 1 Srivastava et al. discloses a method for obtaining closed form expressions for subsurface temperature depth distribution along with its error bounds (see Summary) by using a stochastic heat conduction equation (see column 3 line 28-31), incorporating random thermal conductivity (see column 3 line 31-34), to obtain a mean and variance in temperature fields for a set of boundary conditions (see column 3 line 34-37), the equation consisting of:

$$\frac{d}{dz}\left\{K(z)\frac{dT}{dz}\right\} = -A(z) \quad \text{(see column 3 line 45 equation 1),}$$

where T is the temperature (°C) (see column 3 line 49), A(z) is the radiogenic heat source (uW/m^3) (see column 3 line 50), $K(z) = \overline{K} + K'(z)$ is the thermal conductivity $(w/m^\circ C)$ (see

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column 4 line 3 equation 4), which is expressed as a sum of a deterministic component and a random component (see column 4 line 1-5), K'(z) is the random component with mean zero and a Gaussian colored noise correlation structure represented by

$$E(K'(z)) = 0$$

$$E(K'(z_1)K'(z_2)) = \sigma_K^2 e^{-p|z_1-z_2|} \sigma$$

(see column 4 line 5-10 equations 5 and 6), where

 $\sigma_{\scriptscriptstyle K}^{\scriptscriptstyle 2}$ is the variance in thermal conductivity (W/m °C)^2

 ρ is the correlation decay parameter m⁻¹ (or $1/\rho$ is the correlation length scale) and z_1 and z_2 are depths (m) (see column 4 line 11-15).

With regard to claim 2, and applying the rejection of claim 1 above, Srivastava et al. discloses the boundary conditions consists of condition of heat sources and is selected from the group consisting of Zero (A(z) = 0), Constant (A(z) = A) and exponentially decreasing with depth (A(z) = $A_0e^{-z/D}$) (see column 1 line 8-11 & column 6 line 25-26).

With regard to claim 3 and applying the rejection of claim 1 above, Srivastava et al. discloses the boundary condition comprises constant surface temperature and constant surface heat flow (see column 1 line 8-11 & column 6 line 25-26).

With regard to claim 4, and applying the rejection of claim 1 above, Srivastava et al. discloses the boundary condition comprises constant surface temperature and constant basal heat flow (see column 1 line 8-11 & column 6 line 25-26).

With regard to claim 5, and applying the rejection of claim 1 above, Srivastava et al. discloses a parameter used is that of radiogenic heat generation (see column 3 line 50).

With regard to claim 6, and applying the rejection of claim 1 above, Srivastava et al. discloses the method is carried out electronically using a computing means with appropriate numerical values given for controlling thermal parameters, computing and plotting the mean and error bounds on the temperature depth distribution (see column 6 line 40-56 and Figures 1 and 2).

With regard to claim 7, and applying the rejection of claim 1 above, Srivastava et al. discloses the subsurface is selected from an oil field, a natural gas field, tectonically active area and a mineral resource area (see Summary & column 1 line 1-8 & column 3 line 1-5).

Conclusion

- 5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.
- U.S. Patent Application Publication No. US 2004/0243311 A1 to Srivastava et al. because it teaches obtaining the analytical closed form solution to mean and variance in heat flow by solving the stochastic heat conduction equation incorporating randomness in thermal conductivity but is not applicable as prior art due to filing dates.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anthony T. Dougherty whose telephone number is (571) 272-2273. The examiner can normally be reached on Monday through Friday from 8 to 5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John E. Barlow can be reached on (571) 272-2269. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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MICHAEL NGHIEM

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